

XC3S200A-4FGG320C

Data Sheet

FPGA Spartan®-3A Family 200K Gates 4032 Cells 667MHz 90nm Technology 1.2V

Manufacturers <u>AMD Xilinx, Inc</u>

Package/Case BGA320

Product Type Programmable Logic ICs

RoHS

Lifecycle



Images are for reference only

Please submit RFQ for XC3S200A-4FGG320C or <u>Emailto:ssales@ovaga.com</u> We will contact you in 12 hours.



General Description

XC3S200A-4FGG320C is a model number of a field-programmable gate array (FPGA) developed by Xilinx, a leading provider of programmable logic devices. Here are some of its features:

Features

It has 200,000 system gates, which means it can implement complex digital circuits.

It has 348 input/output (I/O) pins, which can be used to interface with external devices.

It operates at a maximum frequency of 400 MHz, which means it can perform millions of operations per second.

It has 320 pins in a Fine-Pitch Ball-Grid Array (FBGA) package, which allows for high-density mounting on a printed circuit board (PCB).

It operates at a supply voltage of 1.2V, which means it consumes less power.

Application

Communications: It can be used to implement high-speed interfaces such as Gigabit Ethernet, USB, and HDMI.

Digital signal processing: It can be used to implement digital filters, modulators, and demodulators.

Industrial control: It can be used to implement control algorithms for manufacturing equipment, robotics, and process control.

Aerospace and defense: It can be used to implement highperformance radar and communication systems.



Related Products



XC18V01S020C

AMD Xilinx, Inc SOP-20



XCF04SV0G20C

AMD Xilinx, Inc TSSOP20



XC6SLX4-2CSG225C

AMD Xilinx, Inc BGA-225



XCV50-6BG256C

AMD Xilinx, Inc BGA256



XCF08PV0G48C

AMD Xilinx, Inc TSOP-48



XC6SLX25-3FTG256C

AMD Xilinx, Inc BGA-256



XC6SLX16-3CSG324C

AMD Xilinx, Inc BGA-324



XCF32PVO48C

AMD Xilinx, Inc TSOP48